

Part Number:

XZBBHA95W

### APOLLO

### PRELIMINARY SPEC



ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

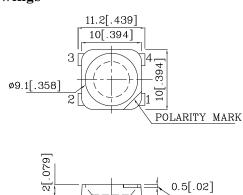
### **Features**

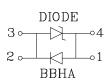
- PLCC-4 PACKAGE.
- SINGLE COLOR.
- HIGH LUMINANCE.
- HIGH POWER, OPERATING CURRENT @ 350MA.
- SUITABLE FOR ALL SMT ASSEMBLY METHODS.
- PACKAGE : 500PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- Rohs Compliant.

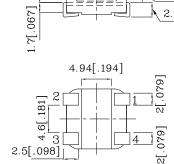


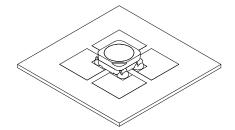


# **Outline Drawings**









### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01)$  unless otherwise noted.
- 3. The device has a single mounting surface. The device must be mounted according to the specifications.
- 4. Specifications are subject to change without notice.

### PATENT PENDING





APOLLO

# **Applications**

- Traffic signaling.
- Backlighting (illuminated advertising, general lighting).
- Interior and exterior automotive lighting.
- Substitution of micro incandescent lamps.
- Portable light source (e.g. bicycle flashlight).
- Signal and symbol luminaire for orientation.
- Marker lights (e.g. steps, exit ways, etc).
- Decorative and entertainment lighting.
- Indoor and outdoor commercial and residential architectural lighting.

# **Application Notes**

- Pressure or stress can damage the encapsulating material and affect the reliability of the LED.
   Precaution should be taken to avoid pressure on the LED encapsulating surface.
- Static electricity and surge damage the LEDS.
   It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.
   All devices, equipment and machinery must be electrically grounded.
- Handling Indications

Use proper handling techniques to prevent damage to the LED surface. Minimize mechanical stress on the LED surface during processing and handling. Do not touch the emitting surface with sharp objects to avoid scratching or damaging the LED.





Figure 1

In general, LEDs should be handled by the sides of the package. Handling instruments should not touch the emitting surface of the LED package.

Figure 2

For automated pick-and-place machines, the pickup nozzle should be larger than the size of the LED reflector area to avoid placing excess pressure on the LED surface.

Published Date : JAN 19,2008 Drawing No : XDSA7717 V11 Checked : B.L.LIU P. 2/6





### APOLLO

Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity (IF=350mA)[1] cd		Luminous Flux (IF=350mA) lm		Wavelength nm λ P	Viewing Angle 2 0 1/2 [2]
				min.	typ.	min.	typ.		
XZBBHA95W	Blue	InGaN	Water Clear	1.5	2.5	4.5	7.6	463	120°

# Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	Pt	1.2	W
Junction Temperature	TJ	110	°C
Operating Temperature	Тор	-40 To +85	°C
Storage Temperature	Tstg	-40 To +85	°C
DC Forward Current[1]	$I_{\mathrm{F}}$	350	mA
Peak Forward Current [3]	IFM	500	mA
Thermal Resistance [1]	$\operatorname{Rth}$	60	°C/W
Electrostatic Discharge Threshold (HBM)	8000	V	

### Notes:

# Electrical / Optical Characteristics at Ta=25°C

Parameter	Symbol	Value	Unit	
Wavelength At peak Emission IF=350mA [Typ.]	λ peak	463	nm	
Dominate Wavelength IF=350mA [Typ.]	λ dom	470	nm	
Spectral Bandwidth at 50%Φ REL MAX IF=350mA [Typ.]	Δλ	22	nm	
Forward Voltage IF=350mA [Min.]		3.0	V	
Forward Voltage IF=350mA [Typ.]	$V_{\rm F}$	3.4		
Forward Voltage IF=350mA [Max.]		3.9		
Temperature Coefficient Of lpeak IF=350mA, -10°C≤ T≤100°C [Typ.]	TC λ peak	0.04	nm/°C	
Temperature Coefficient Of Idom IF=350mA, -10°C≤ T≤100°C [Typ.]	TC λ dom	0.03	nm/°C	
Temperature Coefficient Of VF IF=350mA, -10°C≤ T≤100°C [Typ.]	TCv	-2.2	mV/°C	

Published Date : JAN 19,2008 Drawing No : XDSA7717 V11 Checked : B.L.LIU P. 3/6

 $<sup>1.</sup> Results \ from \ mounting \ on \ PC \ board \ FR4 (pad \ size \ge 100 mm^2 \ per \ pad), \ mounted \ on \ pc \ board-metal \ core \ PCB \ is \ recommend for \ lowest \ thermal \ Resistance.$ 

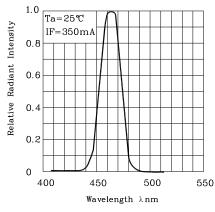
 $<sup>2.0\,1/2</sup>$  is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

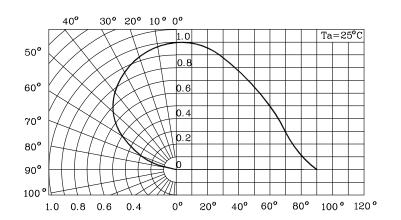
<sup>3.1/10</sup> Duty Cycle, 0.1ms Pulse Width.



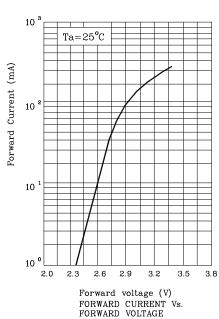
APOLLO

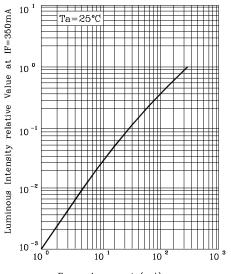
## **XZBBHA95W**



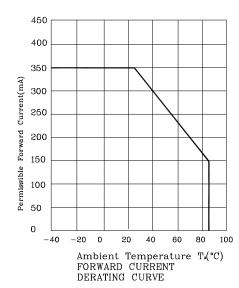


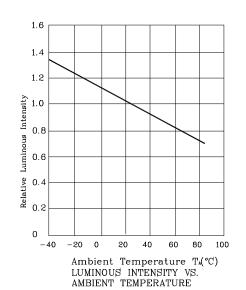
RELATIVE INTENSITY Vs. WAVELENGTH





Forward current (mA) LUMINOUS INTENSITY Vs. FORWARD CURRENT



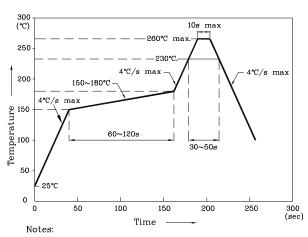


 $Published \ Date: JAN \ 19,2008 \qquad \qquad Drawing \ No: XDSA7717 \qquad \qquad V11 \qquad \qquad Checked: B.L.LIU \qquad \qquad P. \ 4/6$ 

APOLLO

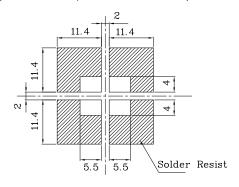
Del. AZDDIIA55W

Reflow Soldering Profile For Lead-free SMT Process.

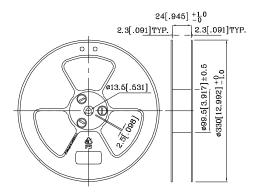


- 1. Maximum soldering temperature should not exceed 260°C.
- 2.Recommended reflow temperature: 145°c-260°C.
- $3.\mbox{Do}$  not put stress to the epoxy resin during high temperatures conditions.

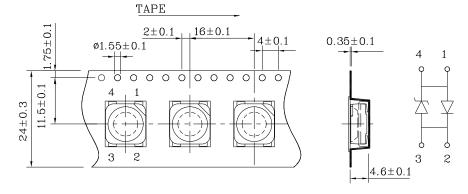
# ❖ Recommended Soldering Pattern (Units: mm; Tolerance:± 0.1)



### \* Reel Dimension



# \* Tape Specification (Units:mm)



### Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

Published Date : JAN 19,2008 Drawing No : XDSA7717 V11 Checked : B.L.LIU P. 5/6



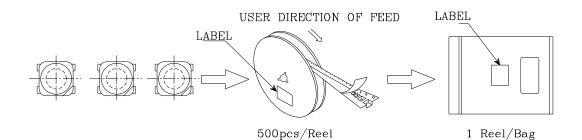
Part Number:

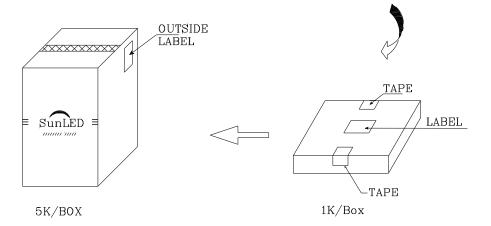
XZBBHA95W

APOLLO

# PACKING & LABEL SPECIFICATIONS

## XZBBHA95W







P/N0 : XZxxx95x

QTY: 500 pcs

CODE: XXX

S/N : XX

LOT NO :



RoHS Compliant

Published Date : JAN 19,2008 Drawing No : XDSA7717 V11 Checked : B.L.LIU P. 6/6